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U.S. UTILITY Patent Application

PATENT NUMBER and
ISSUE DATE

APPL NUM 10068400	FILING DATE 02/06/2002	CLASS 525 ¹⁹⁶	SUBCLASS 272,2	GAU 1711 ¹²³	EXAMINER Haran
**APPLICANTS: Kobayashi Shigetaka; Yamada Takeshi; Hanada Masaki;					
**CONTINUING DATA VERIFIED: - none - JTA					
BEST AVAILABLE COPY					
** FOREIGN APPLICATIONS VERIFIED: JAPAN 2001-036209 02/13/2001 JTA					
PG-PUB <input type="checkbox"/>		DO NOT PUBLISH <input type="checkbox"/>		RESCIND <input type="checkbox"/>	
Foreign priority claimed <input checked="" type="checkbox"/> yes <input type="checkbox"/> no				ATTORNEY DOCKET NO	
35 USC 119 conditions met <input checked="" type="checkbox"/> yes <input type="checkbox"/> no				JP920000346US1	
Verified and Acknowledged Examiners's initials JTA					
TITLE : Bonding method and apparatus					
U.S. DEPT. OF COMM./PAT. & TM-PTO-436L (Rev. 12-94)					

NOTICE OF ALLOWANCE MAILED		Assistant Examiner		CLAIMS ALLOWED	
				Total Claims	Print Claim for O.G.
ISSUE FEE		Primary Examiner		DRAWING	
Amount Due	Date Paid			Sheets Drwg.	Figs. Drwg.
<input type="checkbox"/> TERMINAL DISCLAIMER		PREPARED FOR ISSUE		Application Examiner	
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